**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.

: 09/735,548

Confirmation No.: 6564

Applicant

KENJI HORII, et al. December 14, 2000

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Filed TC/A.U.

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APR 1 2 2004

Examiner Docket No. : Tran, Len

056208.49487US

OFFICE OF PETITIONS

Customer No.

23911

Title

: METHOD OF BONDING METAL PLATES, APPARATUS

THEREFOR AND HOT STRIP MILL

## RESPONSE UNDER 37 C.F.R. §1.116

Mail Stop: Petition

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the enclosed Petition to Revive an Abandoned Application and in response to a Final Patent Office Action of January 16, 2003 which was sent to an incorrect address, Applicants provide the following amendments and comments concerning the allowability of the subject matter of claims 1, 2 and 47-49.

Amendments to the Specification begin on page  $\underline{2}$  of this paper.

Remarks begin on page 4 of this paper.